

Matrix Opto. Co., Ltd -MG911 GaAs Hall Element-

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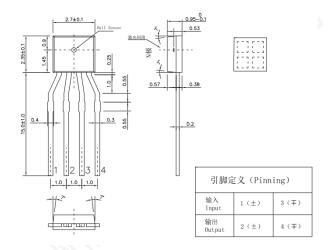
High Sensitive GaAs Hall Element

Excellent Thermal Characteristics

Thin-type SIP Package

Shipped in Bulk by Pack (500pcs devices per pack)

Dimensional Drawing (Unit: mm)



Absolute Maximum Rating

Operating Temperature Range Storage Temperature Range Maximum Input Current *I*_{cmax} -40°C ~ 125°C -40°C ~ 150°C 12mA

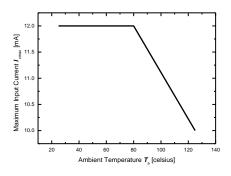


Figure 1. Maximum input current I_{cmax}

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Electrical Characteristics (RT=25°C)

Item	Symbol	Test Condi.	Min.	Тур.	Max.	Unit
Hall Voltage	И	B = 50mT, <i>I</i> c=5mA <i>T</i> a = RT	72	90	108	mV
Input/Output Resist.	R in/out	B = 0mT, I _C = 0.1mA T _a = RT	650	750	850	Ω
Offset Voltage	Vos	B = 0mT, <i>I</i> _c = 5mA T _a = RT	-5	~	+5	mV
Temp. Coeffi. of V_{H}	α / 4	B = 50mT, I _C =5mA, T _a = 25°C ∼ 125°C		$\langle \rangle$	0.06	%/°C
Temp. Coeffi. of R in	α R in	$B = 0 \text{mT}, I_{\text{C}} = 0.1 \text{mA},$ $T_{\text{a}} = 25^{\circ}\text{C} \sim 125^{\circ}\text{C}$	Ę.	k	0.3	%/°C
Linearity of \mathcal{U}_{H}	۵ K	B = 0.01 - 0.05T, I _C =5mA T _a = RT	-2		+2	%

 Table 1. Electrical Characteristics of MG911.

Note:

1. $\boldsymbol{V}_{\mathrm{H}} = \boldsymbol{V}_{\mathrm{H}-\mathrm{M}} - \boldsymbol{V}_{\mathrm{os}}$

In which $V_{\text{H-M}}$ is the Output Hall Voltage, V_{H} is the Hall Voltage and V_{os} is the offset Voltage under

the identical electrical stimuli.

2.
$$\alpha V_{\rm H} = \frac{1}{V_{\rm H} (T_{a1})} \times \frac{V_{\rm H} (T_{a2}) - V_{\rm H} (T_{a1})}{T_{a2} - T_{a1}} \times 100$$

 $T_{a1} = 25^{\circ}{\rm C}, \quad T_{a2} = 125^{\circ}{\rm C}$
3. $\alpha R_{\rm in} = \frac{1}{R_{\rm in} (T_{a1})} \times \frac{R_{\rm in}(T_{a2}) - R_{\rm in} (T_{a1})}{T_{a2} - T_{a1}} \times 100$
 $T_{a1} = 25^{\circ}{\rm C}, \quad T_{a2} = 125^{\circ}{\rm C}$
4. $\Delta K = \frac{K(B_1) - K(B_2)}{\frac{K(B_1) + K(B_2)}{2}} \times 100 \quad K = \frac{V_{\rm H}}{I_c \times B}$
 $B_1 = 0.05T, \quad B_2 = 0.01T$

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Characteristic Curves

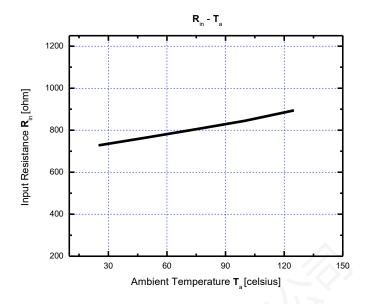


Figure 2. Input resistance R_{in} as a function of ambient temperature $T_{a.}$

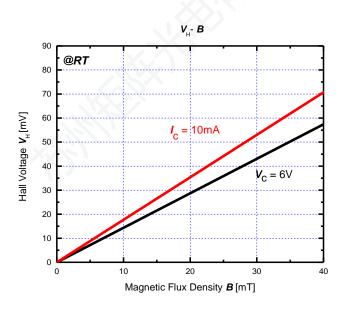


Figure 3. Hall voltage $V_{\rm H}$ as a function of magnetic flux density **B**.

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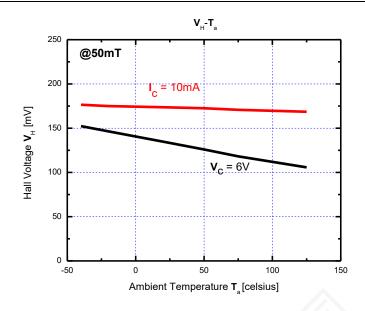


Figure 4. Hall voltage $V_{\rm H}$ as a function of ambient temperature $T_{\rm a.}$

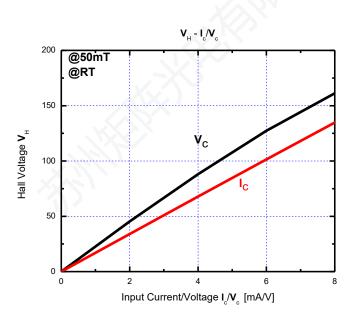


Figure 5. Hall voltage $V_{\rm H}$ as a function of electrical stimuli $I_{\rm c}/V_{\rm c}$.



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Reliability Test Terms

No.	Terms	Conditions	Duration
1	High Temperature Storage (HTS)	【JEITA EIAJ ED-4701】 <i>T</i> a =150(0~+10)℃	1000 hrs
2	Heat Cycle (HC)	【JEITA EIAJ ED-4701】 ✔a=-55°C~150 °C high temp normal temp low temp. 30 min - 5 min - 30 min	50 cycles
3	Temp. Humidity Storage (THS)	【JEITA EIAJ ED-4701】 <i>T_a</i> =85±3 ℃, <i>R</i> _H =85±5 %	1000 hrs
4	Resist. to Hand Soldering Heat (RHSH)	【JEITA EIAJ ED-4701】 Dipped in the 300±5 °C solder up to the 1 mm part from the body	5 sec
5	High Temp. Operating (HTO)	<i>T</i> ª =125 °C , <i>V</i> c =7.5V	1000 hrs

Table 2. Reliability Test Terms, Conditions and Duration.

Criteria:

- Variation of Hall Voltage $V_{\rm H}$ and input/output resistances $R_{\rm in/out}$ are less than 20%.

- Variation of offset voltage V_{os} is less than ±16mV.

- Other parameters in **Table 1**. are still within their ranges stated in **Table 1**.



Soldering Conditions

The following conditions should be preserved. Solder ability should be checked by yourself, because it is

depend on solder paste material and other parameters.

Material of solder flux

- Use the resin based flux and refrain from using organic or inorganic acid based and water-soluble one.

Cleansing of solder flux conditions

- Use Ethanol or Isopropyl alcohol as cleansing material.
- Process temperature should be 50 °C or less.
- Duration should be 5 minutes or less.

Hand soldering conditions

- Apart from the mold resin more than 1mm.
- Solder at temperature 300 °C for less than 5s.

Wave soldering conditions

- Temperature in Pre-heating zone should be lower than 150°C.
- Temperature in Soldering zone should be lower than 280°C.



Precautions for ESD

This product is the device that is sensitive to ESD (Electrostatic Discharge). Handling Hall Elements with

the ESD-Caution mark under the environment in which

- Static electrical charge is unlikely to arise (Ex: Relative Humidity over 40%RH).
- Wearing the anti-static suit and wristband when handling the devices.
- Implementing measures against ESD as for containers that directly touch the devices.

Precautions for Storage

- Products should be stored at an appropriate temperature and humidity (5°C to 35°C, 40%RH to

60%RH) after the unsealing of the MBB. Keeping products away from chlorine and corrosive gas.

- For storage longer than 2 years

Products are sealed in MBB with a desiccant. It is recommended to store in nitrogen atmosphere with

MBB sealed. Oxygen and H₂O of atmosphere oxidizes leads of products and lead solder ability get

worse.

Precautions for Safety

- Do not alter the form of this product into a gas, powder or liquid through burning, crushing or chemical

processing.

- Observe laws and company regulations when discarding this product.